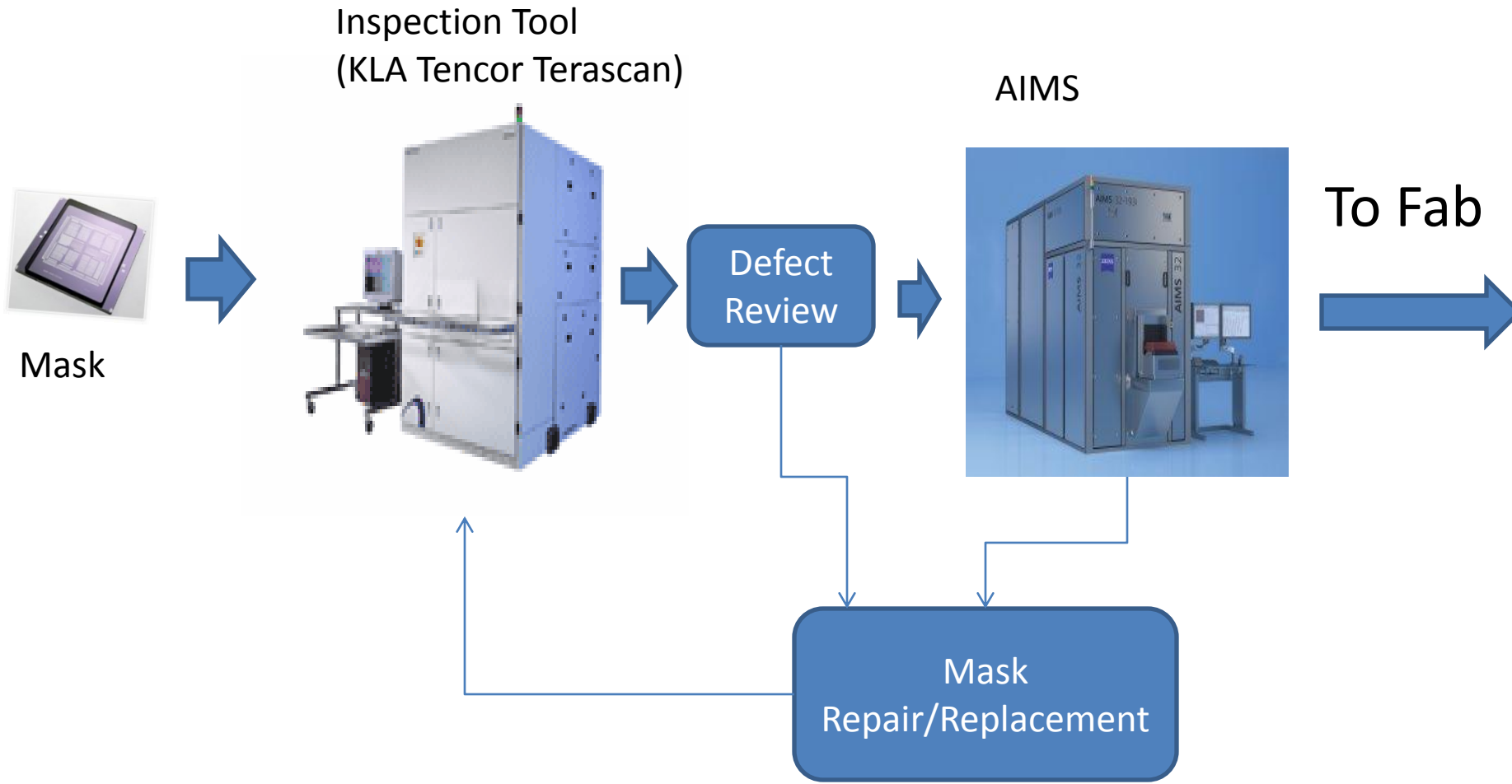
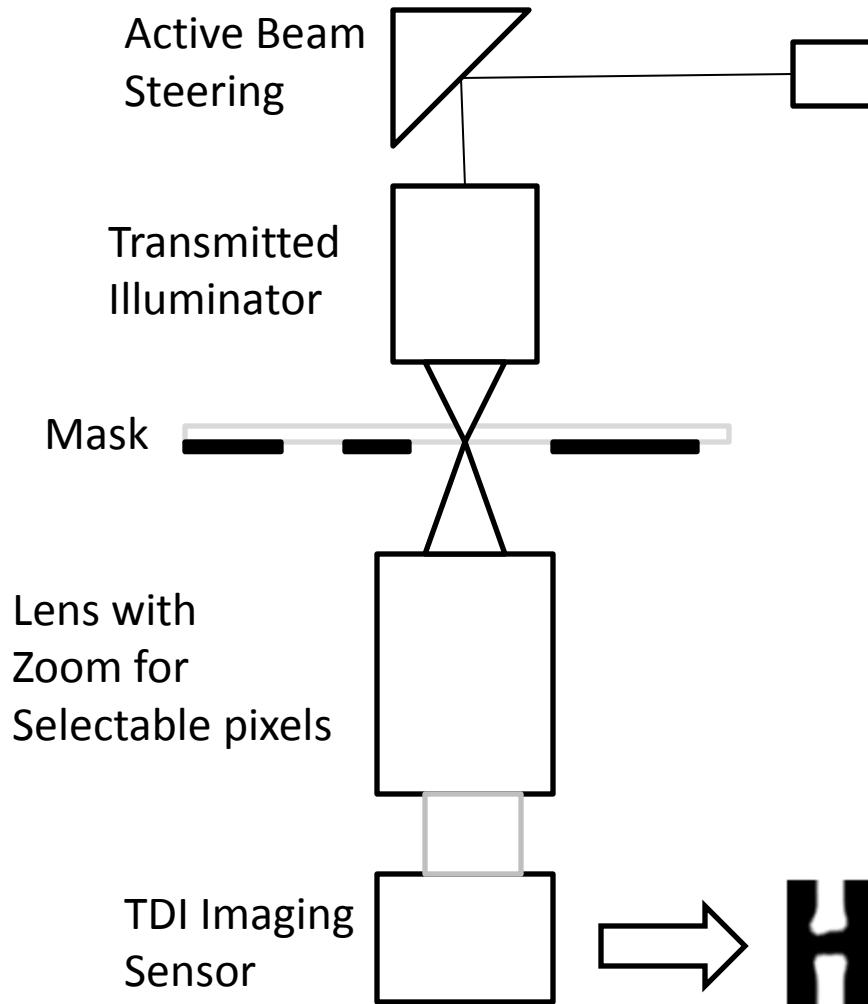


Mask Inspection

Inspection Flow



Inspection Tool



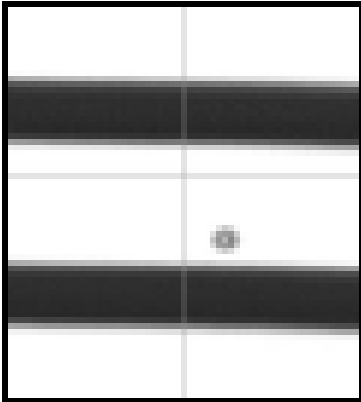
Key Features:

- Transmitted Illuminator allows different contrast for binary and PSM
- Time Domain Integration (TDI) sensor: Faster, lower light levels required compared to CCD

Inspection Tool

- Modes: Die-die and die-database
- Defects <20nm can be detected
- Current tools have reflection illumination also
- Generates 1000+ defects, most nuisance

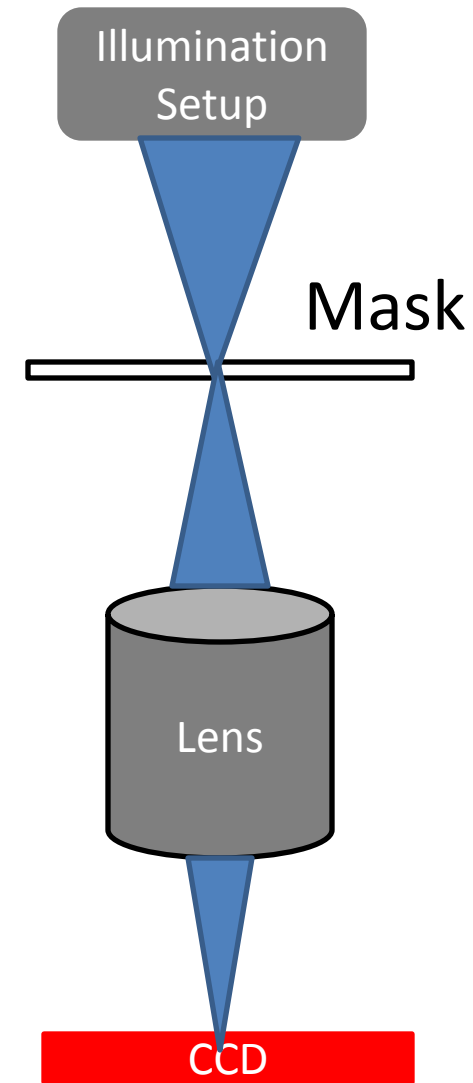
Defect Review



Criteria for Defect classification:

- Size
- Type
- Location
- wafer CD change(simulation)

Aerial Imaging Measurement System(AIMS)



Aerial Imaging Measurement System(AIMS)

- Gold Standard
- Emulates Stepper with adjustable NA, exposure, etc.
- Image equivalent to that on photo resist

Issue:

- Too slow